



SPECIFICATIONS ($T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted)									
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT			
Static									
Drain-source breakdown voltage	V_{DS}	$V_{GS} = 0\text{ V}, I_D = 250\text{ }\mu\text{A}$	Ch-1	30	-	-	V		
			Ch-2	30	-	-			
Gate-source threshold voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	Ch-1	1.1	-	2.4	V		
			Ch-2	1.1	-	2.2			
Gate-source leakage	I_{GSS}	$V_{DS} = 0\text{ V}, V_{GS} = +20\text{ V}, -16\text{ V}$	Ch-1	-	-	± 100	nA		
		$V_{DS} = 0\text{ V}, V_{GS} = +16\text{ V}, -12\text{ V}$	Ch-2	-	-	± 100			
Zero Gate voltage drain current	I_{DSS}	$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}$	Ch-1	-	-	1	μA		
			Ch-2	-	60	400			
		$V_{DS} = 30\text{ V}, V_{GS} = 0\text{ V}, T_J = 55\text{ }^\circ\text{C}$	Ch-1	-	-	5			
			Ch-2	-	350	4000			
On-state drain current ^b	$I_{D(on)}$	$V_{DS} \geq 5\text{ V}, V_{GS} = 10\text{ V}$	Ch-1	20	-	-	A		
			Ch-2	20	-	-			
Drain-source on-state resistance ^b	$R_{DS(on)}$	$V_{GS} = 10\text{ V}, I_D = 10\text{ A}$	Ch-1	-	0.00230	0.00307	Ω		
		$V_{GS} = 10\text{ V}, I_D = 10\text{ A}$	Ch-2	-	0.00070	0.00105			
		$V_{GS} = 4.5\text{ V}, I_D = 5\text{ A}$	Ch-1	-	0.00380	0.00530			
		$V_{GS} = 4.5\text{ V}, I_D = 5\text{ A}$	Ch-2	-	0.00095	0.00145			
Forward transconductance ^b	g_{fs}	$V_{DS} = 15\text{ V}, I_D = 25\text{ A}$	Ch-1	-	65	-	S		
		$V_{DS} = 15\text{ V}, I_D = 25\text{ A}$	Ch-2	-	135	-			
Dynamic ^a									
Input capacitance	C_{iss}	Channel-1 $V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	Ch-1	-	1300	-	pF		
			Ch-2	-	5230	-			
Output capacitance	C_{oss}		Ch-1	-	700	-			
			Ch-2	-	2920	-			
Reverse transfer capacitance	C_{rss}		Channel-2 $V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V}, f = 1\text{ MHz}$	Ch-1	-	35		-	
				Ch-2	-	360		-	
C_{rss}/C_{iss} ratio				Ch-1	-	0.027		0.054	
				Ch-2	-	0.069		0.140	
Total gate charge	Q_g	$V_{DS} = 15\text{ V}, V_{GS} = 10\text{ V}, I_D = 10\text{ A}$		Ch-1	-	19	29	nC	
		$V_{DS} = 15\text{ V}, V_{GS} = 10\text{ V}, I_D = 10\text{ A}$		Ch-2	-	83	125		
		$V_{DS} = 15\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 10\text{ A}$		Ch-1	-	9	14		
		$V_{DS} = 15\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 10\text{ A}$		Ch-2	-	38.6	58		
Gate-source charge	Q_{gs}	Channel-1 $V_{DS} = 15\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 10\text{ A}$	Ch-1	-	4.4	-			
			Ch-2	-	17	-			
Gate-drain charge	Q_{gd}		Channel-2 $V_{DS} = 15\text{ V}, V_{GS} = 4.5\text{ V}, I_D = 10\text{ A}$	Ch-1	-	2	-		
				Ch-2	-	9.2	-		
Output charge	Q_{oss}			$V_{DS} = 15\text{ V}, V_{GS} = 0\text{ V}$	Ch-1	-	17	-	
				Ch-2	-	46	-		
Gate resistance	R_g			$f = 1\text{ MHz}$	Ch-1	0.2	1	2	Ω
					Ch-2	0.1	0.4	0.8	



SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Dynamic ^a							
Turn-on delay time	t _{d(on)}	Channel-1 V _{DD} = 15 V, R _L = 1.5 Ω I _D ≅ 10 A, V _{GEN} = 4.5 V, R _g = 1 Ω	Ch-1	-	18	35	ns
Rise time	t _r		Ch-2	-	34	70	
Turn-off delay time	t _{d(off)}	Channel-2 V _{DD} = 15 V, R _L = 3 Ω I _D ≅ 5 A, V _{GEN} = 4.5 V, R _g = 1 Ω	Ch-1	-	95	190	
			Ch-2	-	116	230	
Fall time	t _f	Channel-1	Ch-1	-	17	35	
			Ch-2	-	45	90	
Turn-on delay time	t _{d(on)}	Channel-2 V _{DD} = 15 V, R _L = 3 Ω I _D ≅ 5 A, V _{GEN} = 10 V, R _g = 1 Ω	Ch-1	-	10	20	
			Ch-2	-	27	50	
Rise time	t _r	Channel-1	Ch-1	-	11	20	
			Ch-2	-	17	35	
Turn-off delay time	t _{d(off)}	Channel-2 V _{DD} = 15 V, R _L = 3 Ω I _D ≅ 5 A, V _{GEN} = 10 V, R _g = 1 Ω	Ch-1	-	5	10	
			Ch-2	-	70	150	
Fall time	t _f	Channel-1	Ch-1	-	20	40	
			Ch-2	-	43	85	
		Channel-2 V _{DD} = 15 V, R _L = 3 Ω I _D ≅ 5 A, V _{GEN} = 10 V, R _g = 1 Ω	Ch-1	-	5	10	
			Ch-2	-	10	20	
Drain-Source Body Diode Characteristics							
Continuous source-drain diode current	I _S	T _C = 25 °C	Ch-1	-	-	26	A
			Ch-2	-	-	122	
Pulse diode forward current ^a	I _{SM}		Ch-1	-	-	130	A
			Ch-2	-	-	130	
Body diode voltage	V _{SD}	I _S = 10 A, V _{GS} = 0 V	Ch-1	-	0.77	1.1	V
		I _S = 3 A, V _{GS} = 0 V	Ch-2	-	0.36	0.60	
Body diode reverse recovery time	t _{rr}	Channel-1 I _F = 10 A, di/dt = 100 A/μs, T _J = 25 °C	Ch-1	-	27	50	ns
			Ch-2	-	55	110	
Body diode reverse recovery charge	Q _{rr}	Channel-1	Ch-1	-	15	30	nC
			Ch-2	-	66	130	
Reverse recovery fall time	t _a	Channel-2 I _F = 10 A, di/dt = 100 A/μs, T _J = 25 °C	Ch-1	-	16	-	ns
			Ch-2	-	30	-	
Reverse recovery rise time	t _b	Channel-2	Ch-1	-	11	-	ns
			Ch-2	-	25	-	

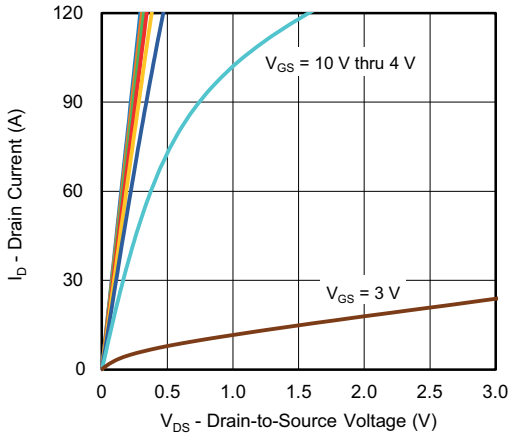
Notes

- a. Guaranteed by design, not subject to production testing
- b. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %

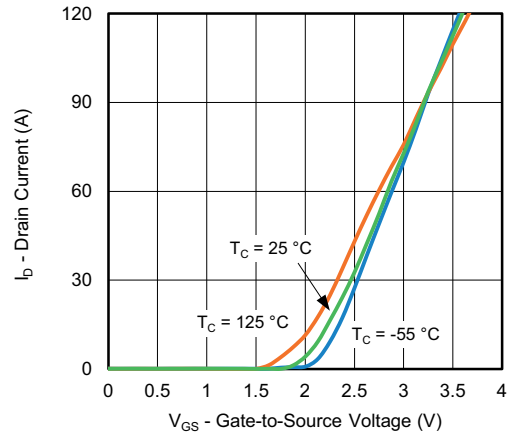
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



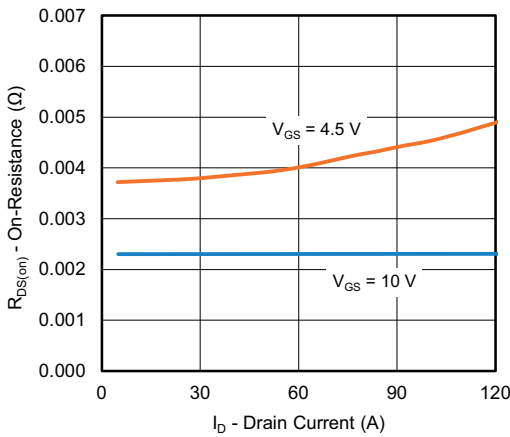
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



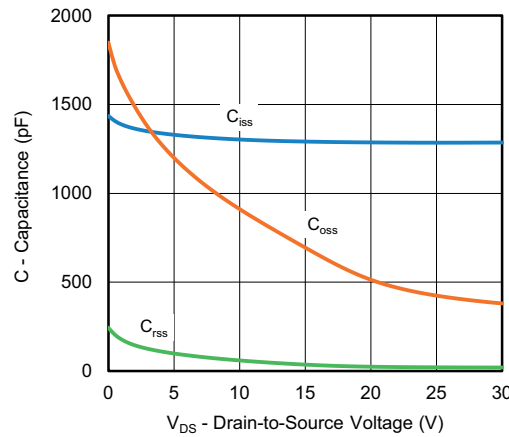
Output Characteristics



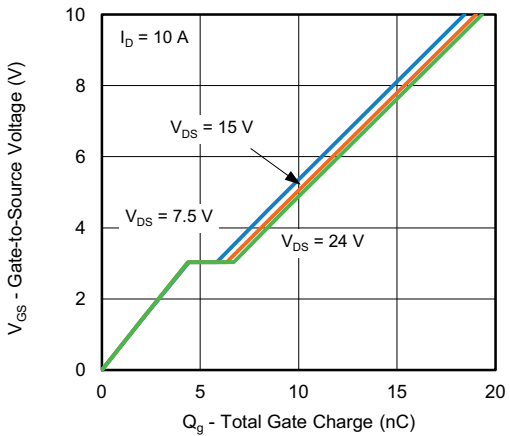
Transfer Characteristics



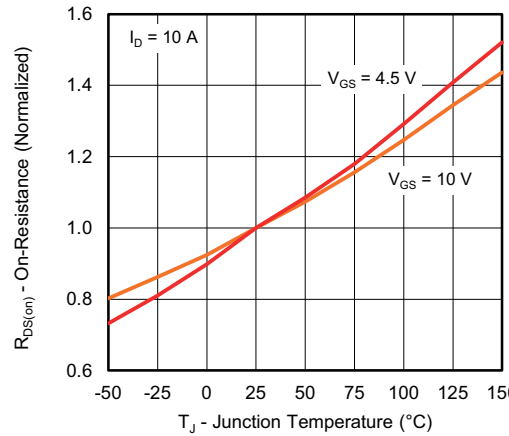
On-Resistance vs. Drain Current



Capacitance

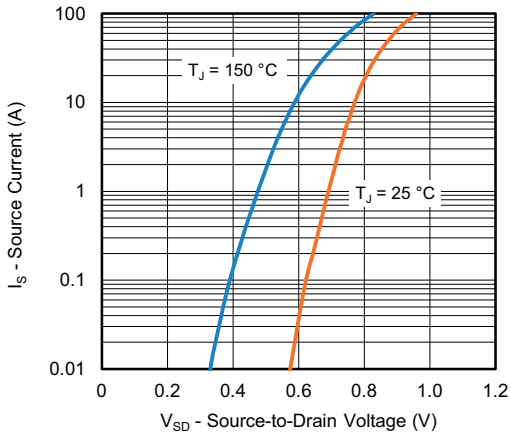


Gate Charge

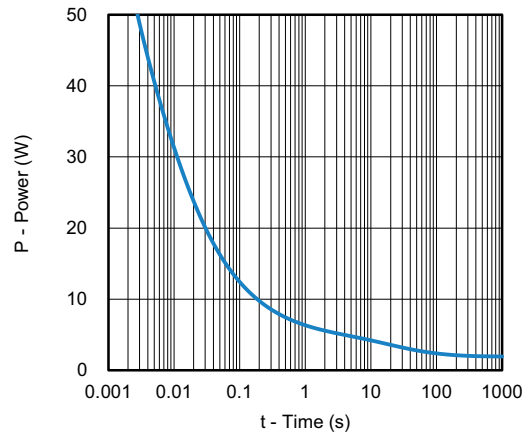


On-Resistance vs. Junction Temperature

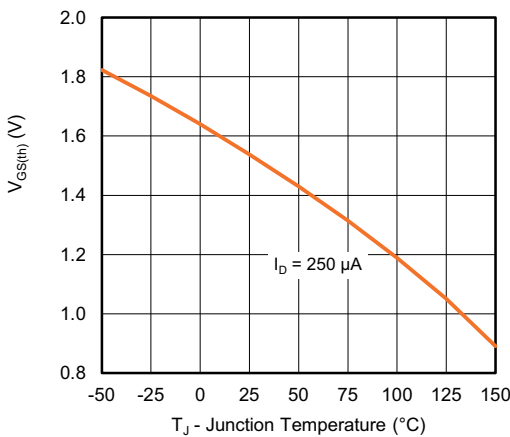
CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



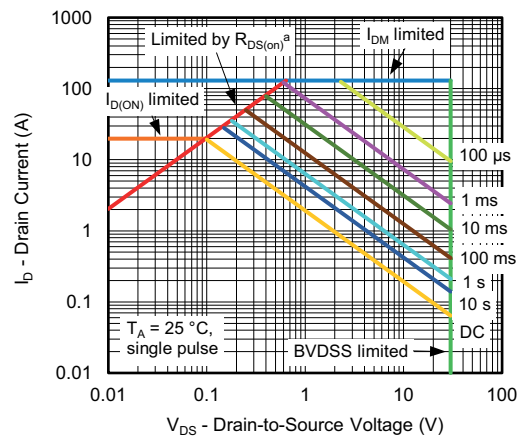
Source-Drain Diode Forward Voltage



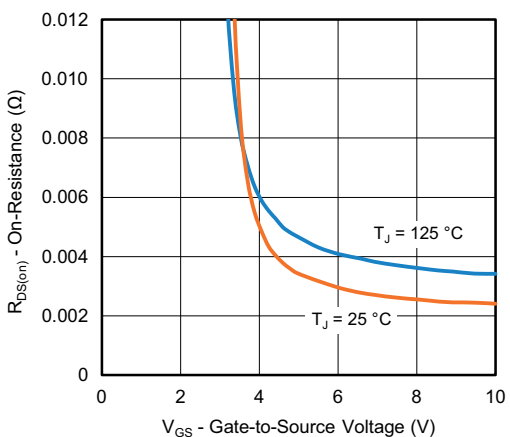
Single Pulse Power, Junction-to-Ambient



Threshold Voltage



Safe Operating Area, Junction-to-Ambient



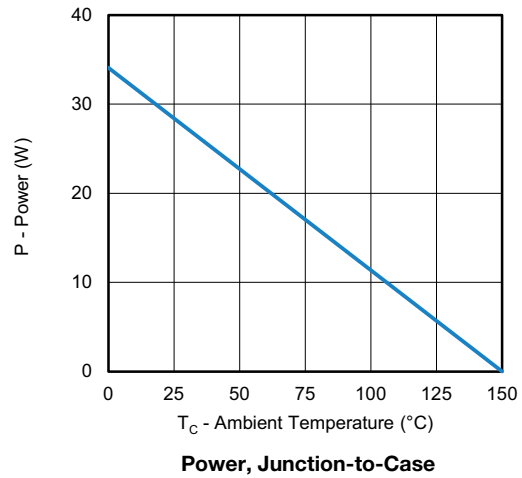
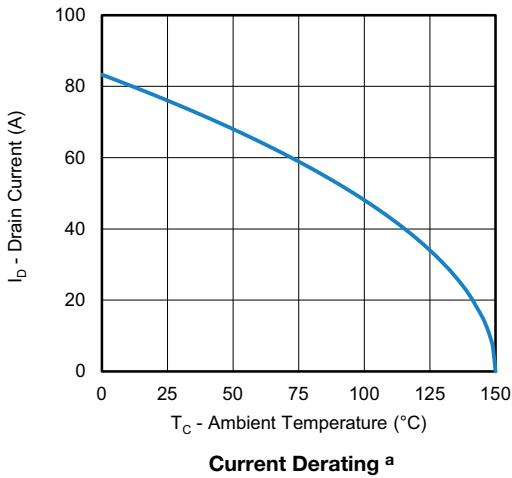
On-Resistance vs. Gate-to-Source Voltage

Note

a. $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified



CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

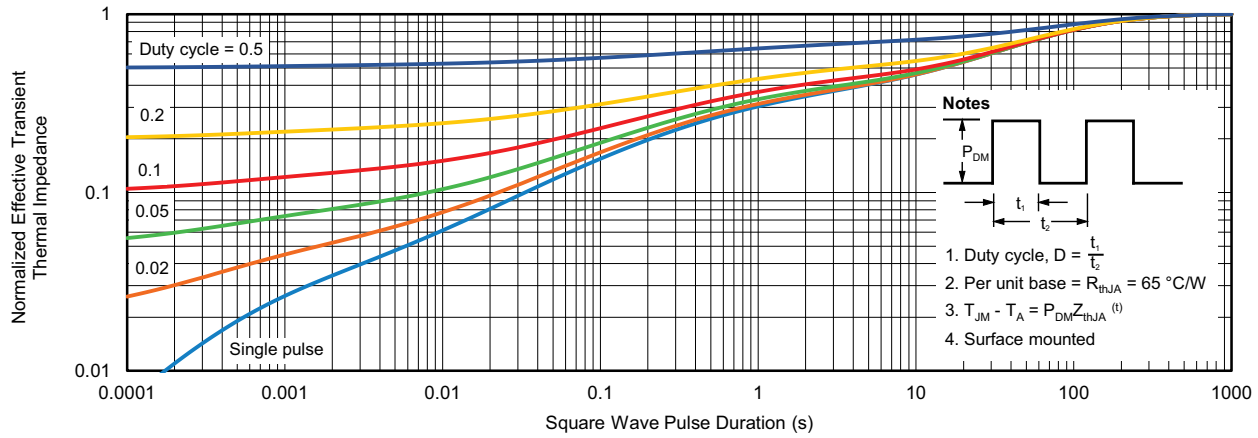


Note

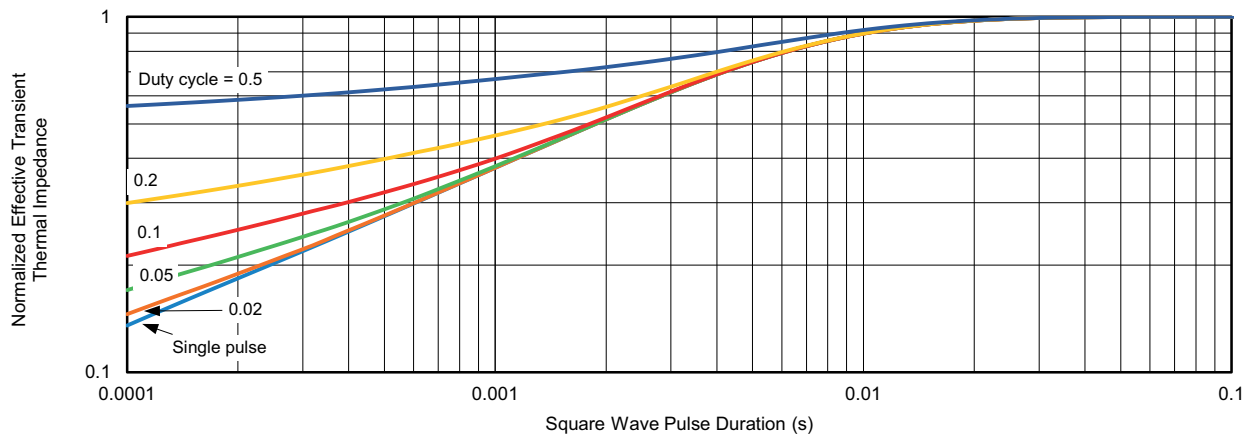
- a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



CHANNEL-1 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

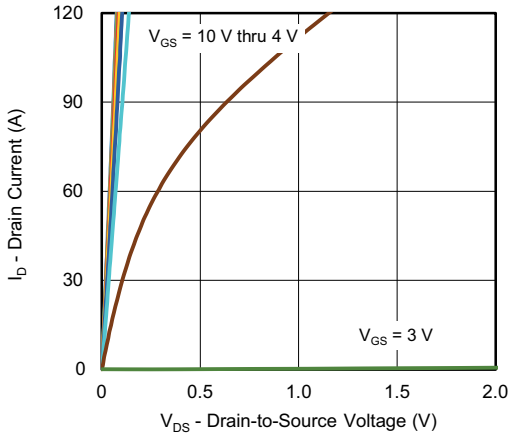


Normalized Thermal Transient Impedance, Junction-to-Ambient

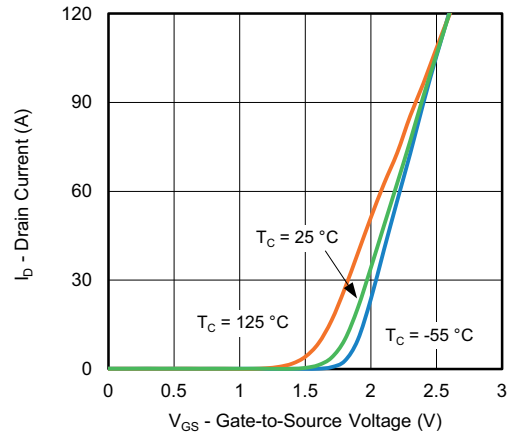


Normalized Thermal Transient Impedance, Junction-to-Case

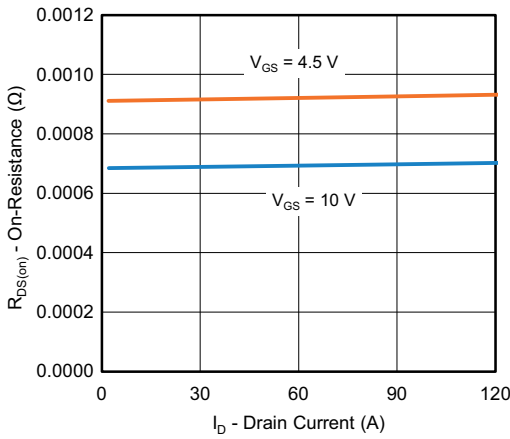
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



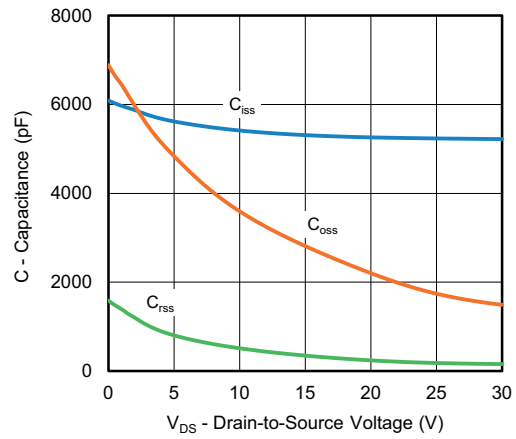
Output Characteristics



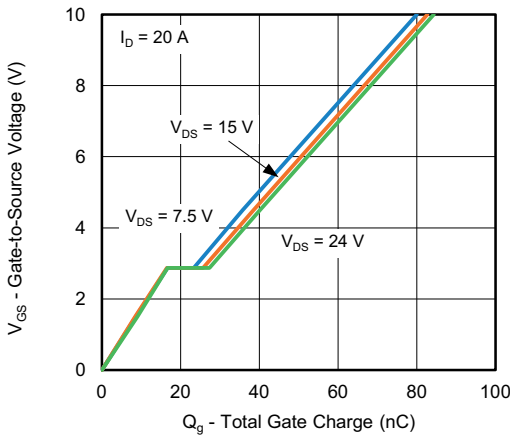
Transfer Characteristics



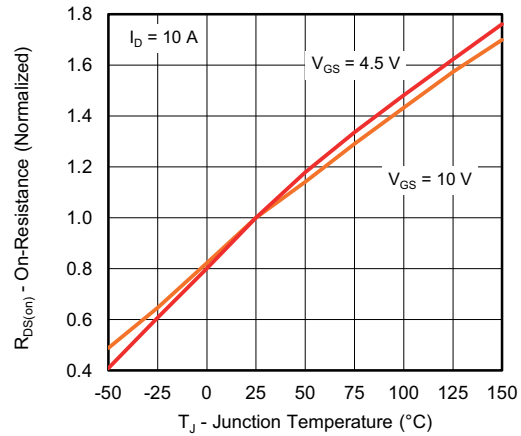
On-Resistance vs. Drain Current



Capacitance



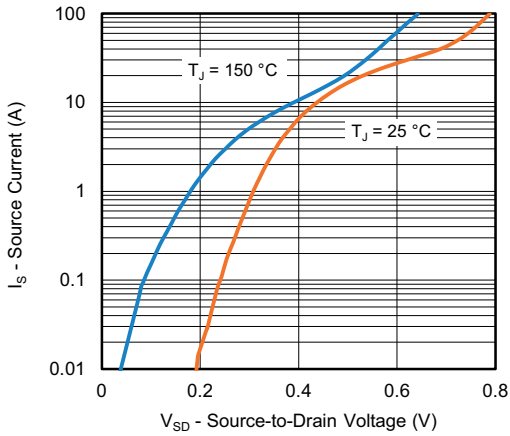
Gate Charge



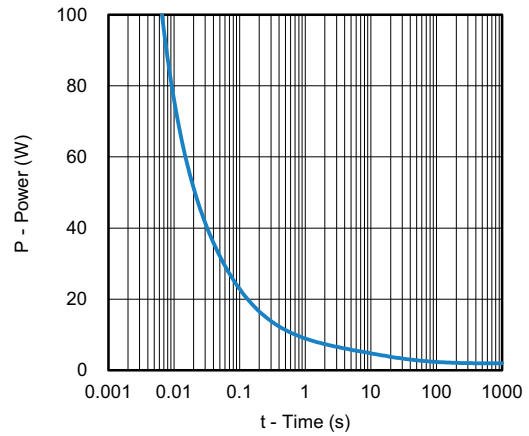
On-Resistance vs. Junction Temperature



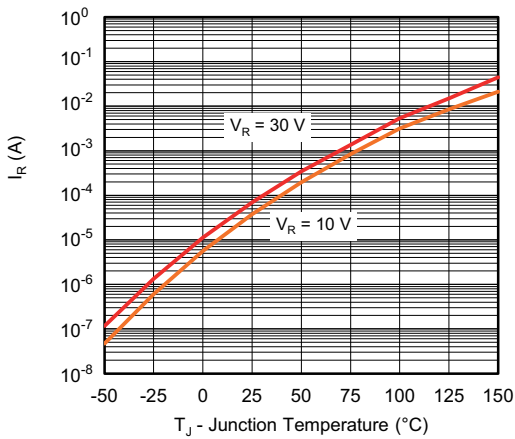
CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



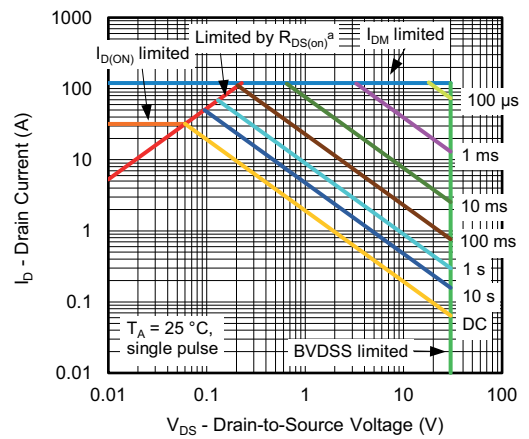
Source-Drain Diode Forward Voltage



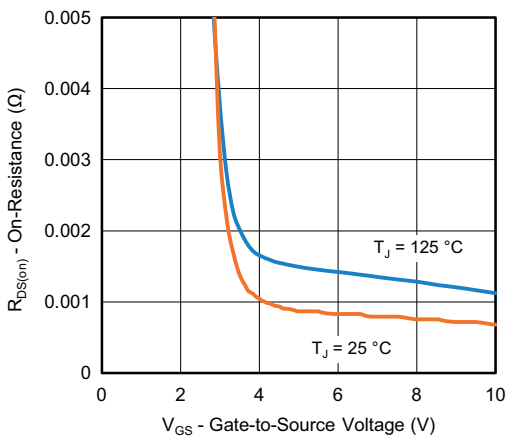
Single Pulse Power, Junction-to-Ambient



Reverse Current (Schottky)



Safe Operating Area, Junction-to-Ambient



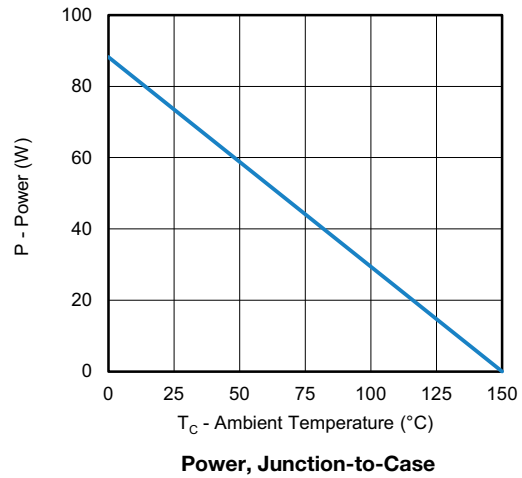
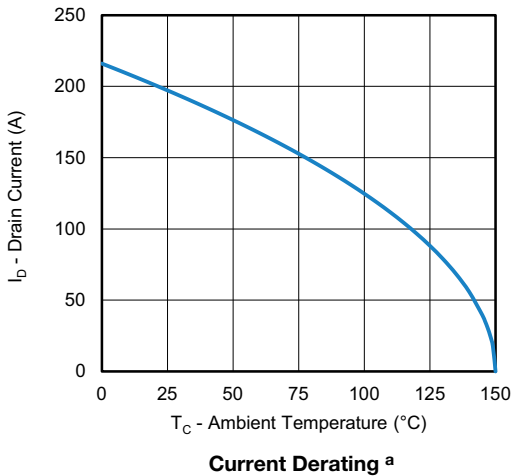
On-Resistance vs. Gate-to-Source Voltage

Note

a. $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified



CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

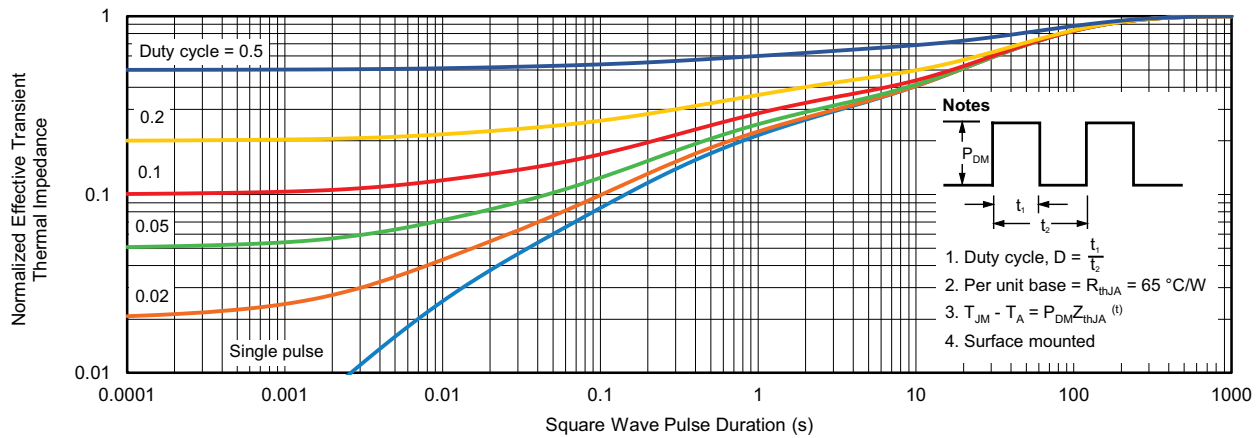


Note

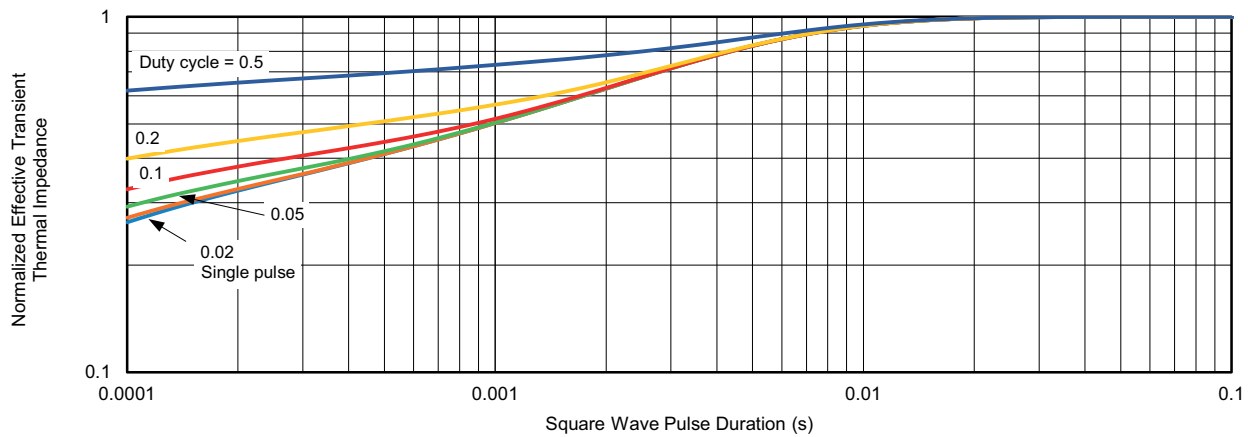
- a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



CHANNEL-2 TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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JONHON

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